

REV	ECN NO	CONTENT	DATE	ENGINEER
A0		INITIAL RELEASE	/	LYX

NOTES:

1. CURRENT RATING: 8A MAX.;
2. DIELECTRIC WITHSTANDING: 100V AC MIN.;
3. TEMPERATURE RANGE: -30°C~85°C;
4. CONTACT RESISTANCE: 40mΩ MAX.;
5. INSULATION RESISTANCE: 100MΩ MIN.;
6. DURABILITY: 10,000 CYCLES MIN.;
7. INSERTION FORCE: 5N~20N;
8. EXTRACTION FORCE:
(1) INITIAL: 8N~20N;
(2) AFTER DURABILITY: 6N~20N.
9. PRODUCT MEET THE REQUEST OF THE RoHS.



RECOMMENDED PCB LAYOUT(T=0.80)
SCALE: 2:1(GENERAL TOLERANCE±0.05)

A1			A4	A5	A6	A7	A8	A9	A10	A11	A12
GND	TX1+	TX1-	VBUS	CC1	D+	D-	SBU1	VBUS	RX2-	RX2+	GND
GND	RX1+	RX1-	VBUS	SBU2	D-	D+	CC2	VBUS	TX2-	TX2+	GND
B12	B11	B10	B9	B8	B7	B6	B5	B4			B1

PIN ASSIGNMENT
(FRONT VIEW)

11	MAIN HOUSING	1 PCS	HIGH TEMPERATURE PLASTIC	BLACK
10	TOP HOUSING	1 PCS	HIGH TEMPERATURE PLASTIC	BLACK
09	BOTTOM HOUSING	1 PCS	HIGH TEMPERATURE PLASTIC	BLACK
08	RUBBER	1 PCS	LSR	BLACK
07	LOW SHELL	1 PCS	STAINLESS STEEL	SOLDER:NI PLATED
06	UPPER SHELL	1 PCS	STAINLESS STEEL	SOLDER:AU GOLD FLASH/NI PLATED
05	INNER SHELL	1 PCS	STAINLESS STEEL	SOLDER:NI PLATED
04	SOLDERING PART	1 PCS	STAINLESS STEEL	SOLDER:NI PLATED
03	PLATE	1 PCS	STAINLESS STEEL	NO PLATING
02	CONTACT B	1 SET	COPPER ALLOY	Au:SEE TABLE A/NI PLATED
01	CONTACT A	1 SET	COPPER ALLOY	Au:SEE TABLE A/NI PLATED
ITEM	PART NAME	Q'TY	MATERIAL	DESCRIPTION

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深圳市步步精科技有限公司

.X: ±0.38 X': ±3'
.XX: ±0.25 X': ±2'
.XXX: ±0.13 .XX': ±1'

NAME: TYPE-C 16P 防水母座 锁板式 沉板1.0
两脚插 L=7.05 舌片外漏1.4 SMT IPX7

APPD JM_Zheng

PJ NO: 126-221-160005-J8G

CHKD HMY

SIZE:A4 DRW NO:

PDWG NO: 0332-1

DR LYX

FINISH:SEE NOTES

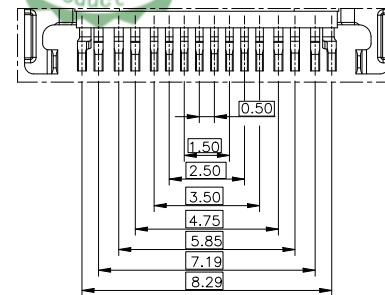
MAT'L:SEE NOTES

SCALE:N/A

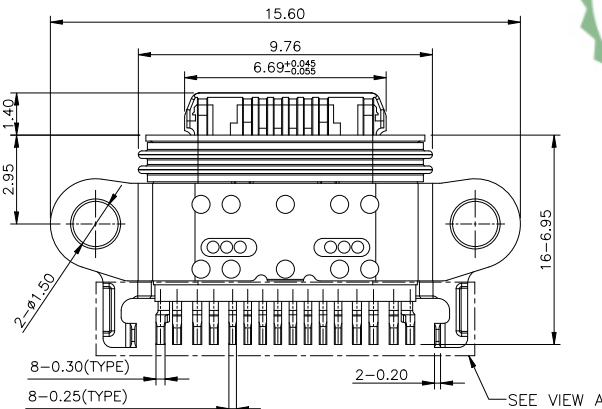
REV:A0

UNIT:mm

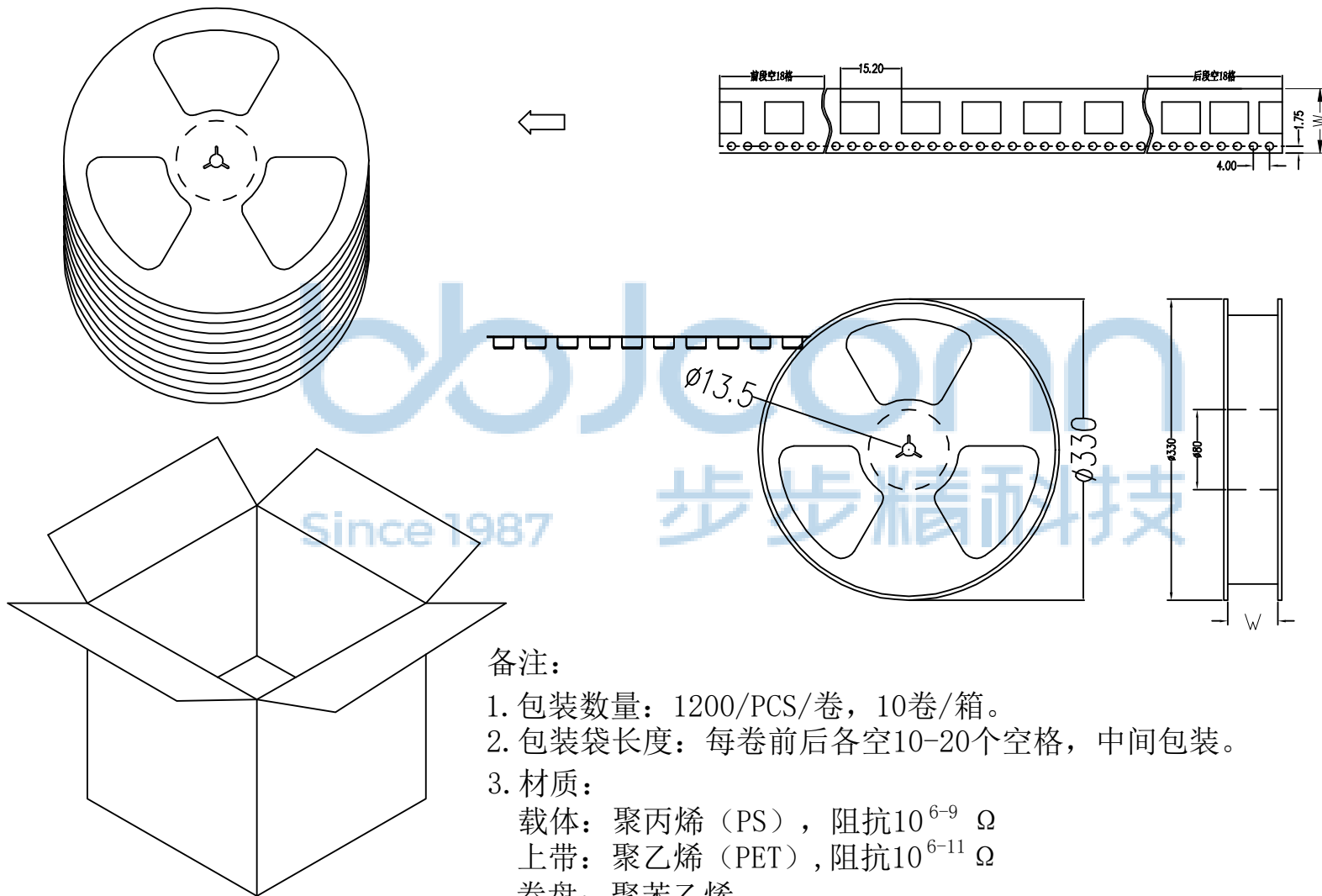
PAGE:1/2



SEE VIEW A



SEE VIEW A



备注:

1. 包装数量: 1200/PCS/卷, 10卷/箱。
2. 包装袋长度: 每卷前后各空10-20个空格, 中间包装。
3. 材质:
载体: 聚丙烯 (PS), 阻抗 $10^{6-9} \Omega$
上带: 聚乙烯 (PET), 阻抗 $10^{6-11} \Omega$
卷盘: 聚苯乙烯。

纸箱规格: 345*345*230MM

纸箱规格: 345*345*350MM

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		.X: ± 0.38 .XX: ± 0.25 .XXX: ± 0.13		X': $\pm 3'$.X': $\pm 2'$.XX': $\pm 1'$		NAME:TYPE-C 16P 防水母座 锁板式 沉板1.0 两脚插 L=7.05 舌片外漏1.4 SMT IPX7		
		APPD	JM_Zheng			PJ NO:126-221-160005-J8G		
		CHKD	HMY			SIZE:A4	DRW NO:	
						FINISH:SEE NOTES		MAT'L:SEE NOTES
				SCALE:N/A		REV:A0	UNIT:mm	PAGE:2/2